

Description

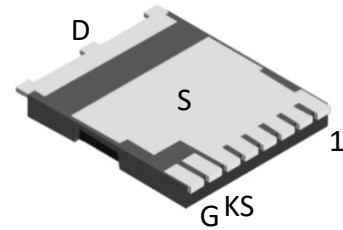
| Product Summary | | |
|-----------------|----------------------------|----------|
| $V_{DS}(V)$ | $R_{DS(on)}(m\Omega)(Typ)$ | $I_D(A)$ |
| 650 | 70@ $V_{GS} = 12V$ | 27 |

Feature

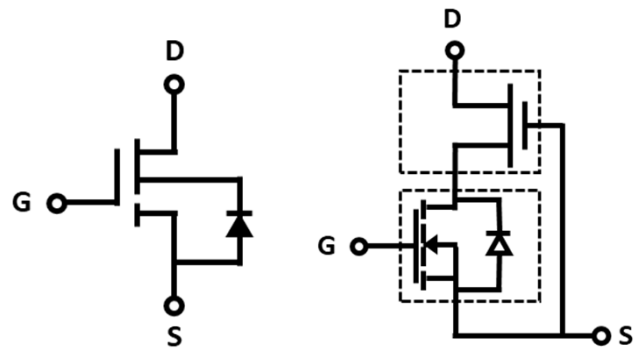
- Easy to use, compatible with standard gate drivers
- Excellent $Q_G \times R_{DS(on)}$ figure of merit (FOM)
- Low Q_{RR} , no free-wheeling diode required
- Low switching loss
- RoHS compliant and Halogen-free

Applications

- High efficiency power supplies
- Telecom and datacom
- Automotive
- Servo motors



TOLL (Bottom View)



Schematic Symbol

Cascode Device Structure

Absolute maximum rating@25°C

| Parameter | | Symbol | Rating | Unit |
|--|---------------------|----------------|------------|------------|
| Drain-Source Voltage | | V_{DS} | 650 | V |
| Gate-Source Voltage | | V_{GS} | ± 20 | V |
| Transient Drain-Source Voltage ¹⁾ | | V_{TDS} | 800 | V |
| Continuous Drain Current | $T_C = 25^\circ C$ | I_D | 27 | A |
| | $T_C = 100^\circ C$ | | 17 | |
| Pulsed Drain Current (Pulse Width: 100 μs) | $T_C = 25^\circ C$ | I_{DM} | 107 | A |
| | $T_C = 100^\circ C$ | | 82 | |
| Power Dissipation | | P_D | 96 | W |
| Soldering Peak Temperature | | T_{CSOLD} | 260 | $^\circ C$ |
| Operating Junction and Storage Temperature | | T_J, T_{STG} | -55 to 150 | $^\circ C$ |

Thermal Resistance

| Parameter | Symbol | Min | Typ | Max | Unit |
|---|-----------------|-----|-----|-----|--------------|
| Thermal Resistance, Junction-to-Case | $R_{\theta JC}$ | - | 1.3 | - | $^\circ C/W$ |
| Thermal Resistance, Junction-to-Ambient ²⁾ | $R_{\theta JA}$ | - | 50 | - | $^\circ C/W$ |

Electrical characteristics per line@25°C (unless otherwise specified)

| Parameter | Symbol | Conditions | | Min. | Typ. | Max. | Units |
|--|--------------------------------------|--|-----------------------|------|-------|------|-------|
| Statistic Characteristics | | | | | | | |
| Maximum Drain-Source Voltage | V _{DS-Max} | V _{GS} = 0V | | 650 | - | - | V |
| Drain-Source Breakdown Voltage | BV _{DSS} | V _{GS} = 0V, I _D = 250μA | | - | 1000 | - | V |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} =700V, V _{GS} =0V | T _J =25°C | - | 8 | 20 | μA |
| | | | T _J =150°C | - | 50 | - | |
| Gate-Body Leakage Current | I _{GSS} | V _{GS} = ±20V, V _{DS} = 0V | | - | - | ±150 | nA |
| Gate Threshold Voltage | V _{GS(th)} | V _{DS} = V _{GS} , I _D = 500μA | | 3.0 | 4.0 | 5.0 | V |
| Gate Threshold Voltage Temperature Coefficient | ΔV _{GS(th)} /T _J | | | - | -10.7 | - | mV/°C |
| Drain-Source On-State Resistance ³⁾ | R _{DS(ON)} | V _{GS} =12V, I _D =4A | T _J =25°C | - | 70 | 90 | mΩ |
| | | | T _J =150°C | - | 140 | - | |
| Dynamic Characteristics | | | | | | | |
| Input Capacitance | C _{ISS} | V _{DS} = 400V, V _{GS} = 0V, f = 1MHz | | - | 540 | - | pF |
| Output Capacitance | C _{OSS} | | | - | 77 | - | |
| Reverse Transfer Capacitance | C _{rss} | | | - | 3 | - | |
| Effective Output Capacitance, Energy Related | C _{o(er)} | V _{GS} = 0V, V _{DS} = 0-400V | | - | 115 | - | pF |
| Effective Output Capacitance, Time Related | C _{o(tr)} | | | - | 210 | - | |
| Output Charge | Q _{OSS} | | | - | 84 | - | nC |
| Turn-on Delay Time | t _{d(on)} | V _{DS} = 400V, I _D = 17A, V _{GS} = 0-12V, R _G = 47Ω | | - | 30 | - | ns |
| Turn-on Rise Time | t _r | | | - | 16 | - | |
| Turn-Off Delay Time | t _{d(off)} | | | - | 80 | - | |
| Turn-Off Fall Time | t _f | | | - | 10 | - | |
| Total Gate Charge | Q _g | V _{DS} = 400V, I _D = 17A, V _{GS} = 0-12V | | - | 12.5 | - | nC |
| Gate-Source Charge | Q _{gs} | | | - | 2.6 | - | |
| Gate-Drain Charge | Q _{gd} | | | - | 4.4 | - | |
| Reverse Diode Characteristics | | | | | | | |
| Diode Forward Voltage | V _{SD} | V _{GS} =0V, I _S =8.5A | | - | 1.3 | - | V |
| | | V _{GS} =0V, I _S =17A | T _J =25°C | - | 1.8 | - | |
| | | | T _J =150°C | - | 2.4 | - | |
| Reverse Recovery Time | t _{rr} | V _{GS} =0V, I _S =17A, V _{DD} =400V, di/dt=1000A/μs | | - | 33 | - | ns |
| Reverse Recovery Charge | Q _{rr} | | | - | 84 | - | μC |

Notes:

- Off-state spike duty cycle < 0.01, spike duration < 2μs
- Device on one layer epoxy PCB for drain connection (vertical and without air stream cooling, with 6cm²copper area and 70μm thickness)
- Dynamic on-resistance; see Figure 18 and 19 for test circuit and configurations

Typical Characteristics

Figure 1. Typical Output Characteristics $T_J=25^{\circ}\text{C}$

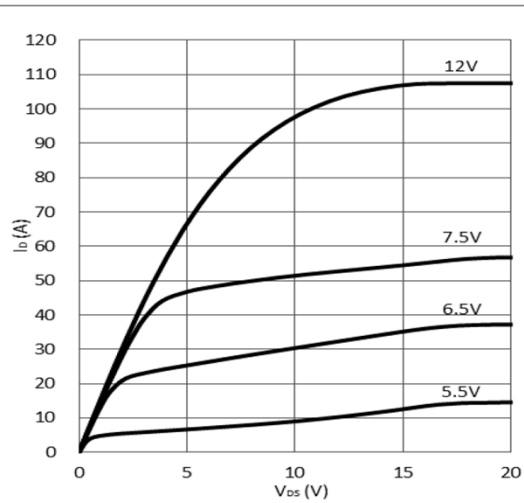


Figure 2. Typical Output Characteristics $T_J=150^{\circ}\text{C}$

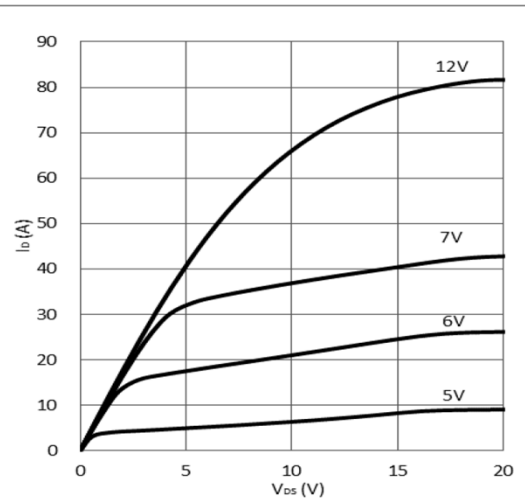


Figure 3. Typical Transfer Characteristics

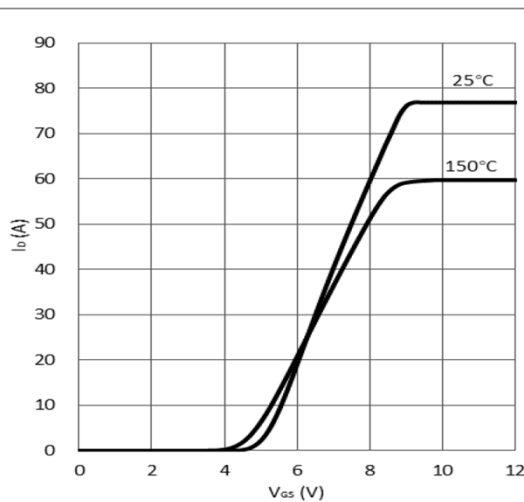


Figure 4. $V_{GS(th)}$ Vs Temperature Characteristics

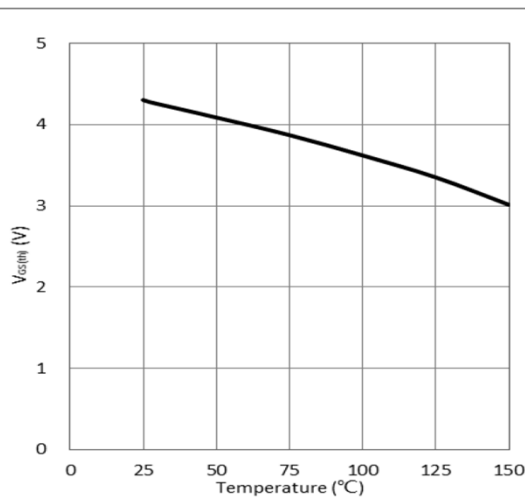


Figure 5. Normalized On-resistance

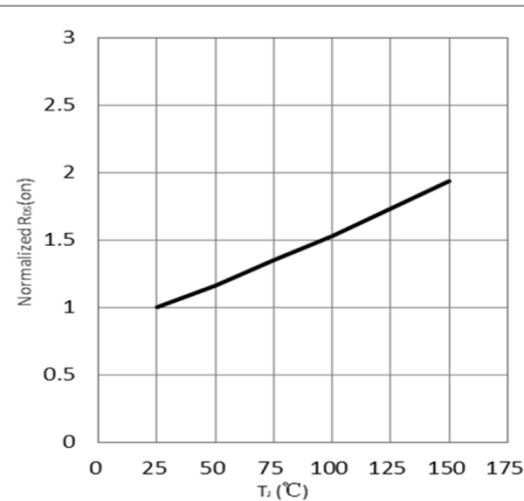


Figure 6. Typical Capacitance

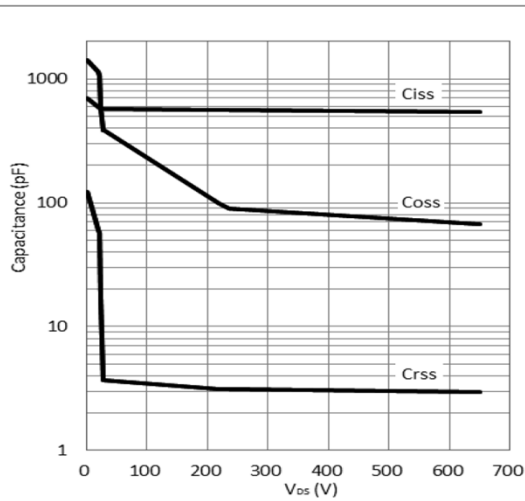
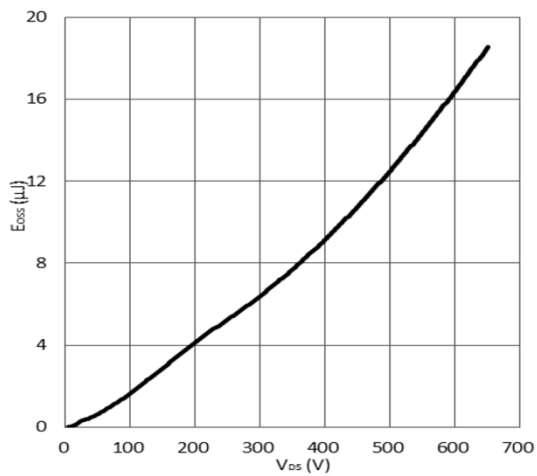
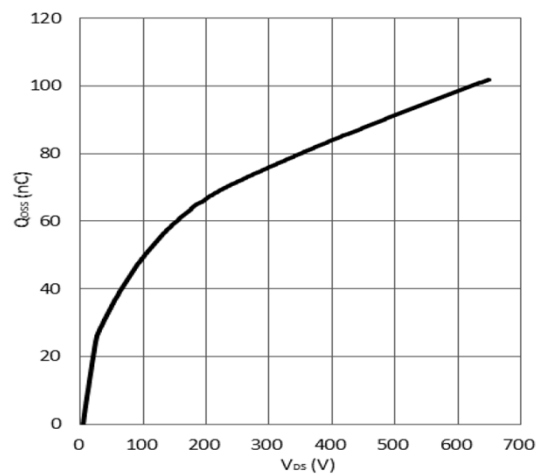


Figure 7. Typical Coss Stored Energy



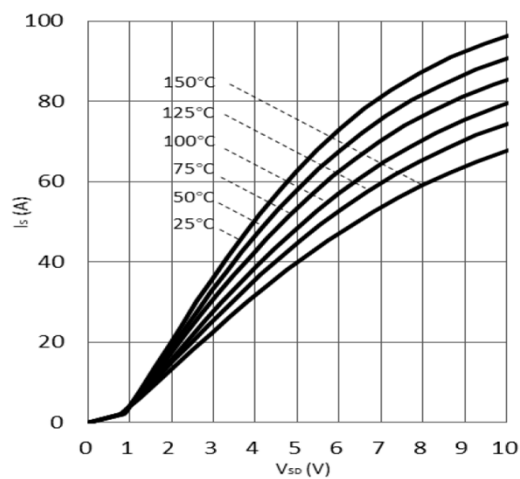
$V_{GS}=0V$, $f=1MHz$

Figure 8. Typical Qoss



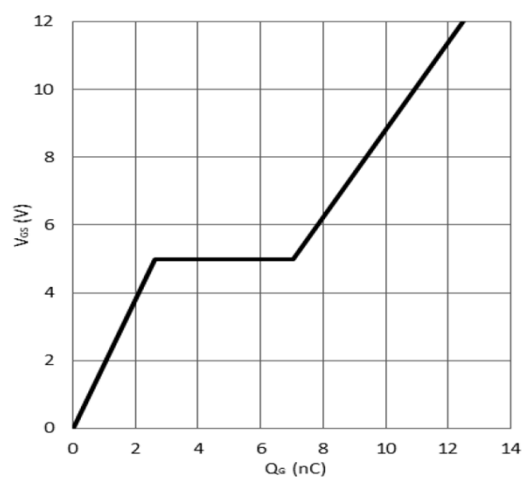
$V_{GS}=0V$, $f=1MHz$

Figure 9. Forward Characteristic of Rev. Diode



$I_S=f(V_{SD})$, Parameter T_J

Figure 10. Typical Gate Charge



$I_{DS}=17A$, $V_{DS}=400V$

Figure 11. Power Dissipation

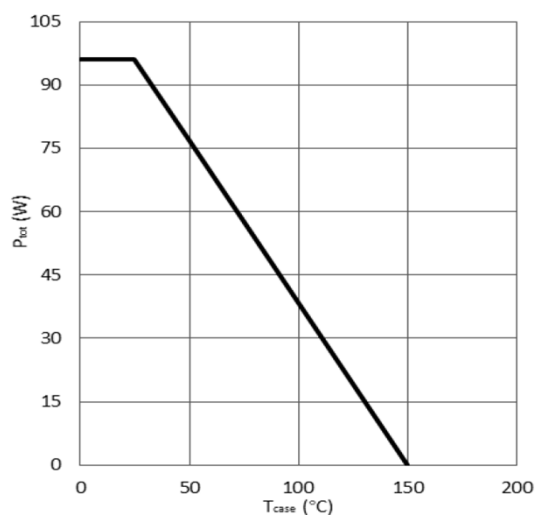


Figure 12. Current Derating

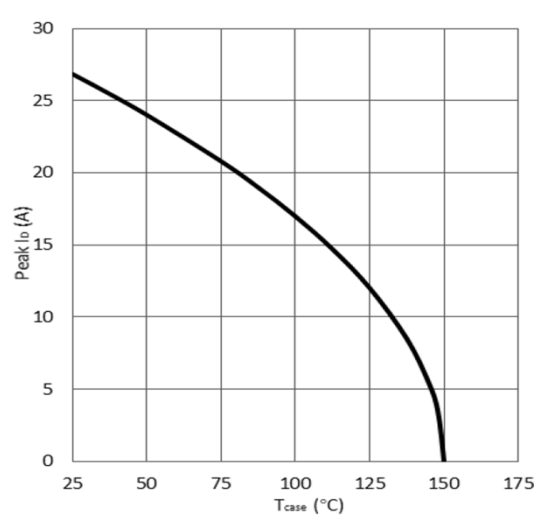


Figure 13. Transient Thermal Resistance

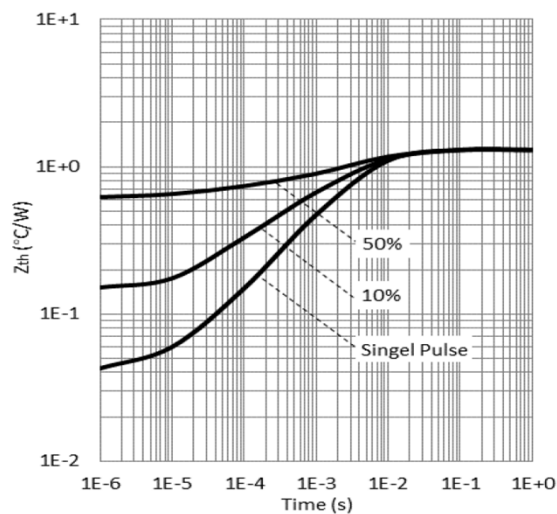
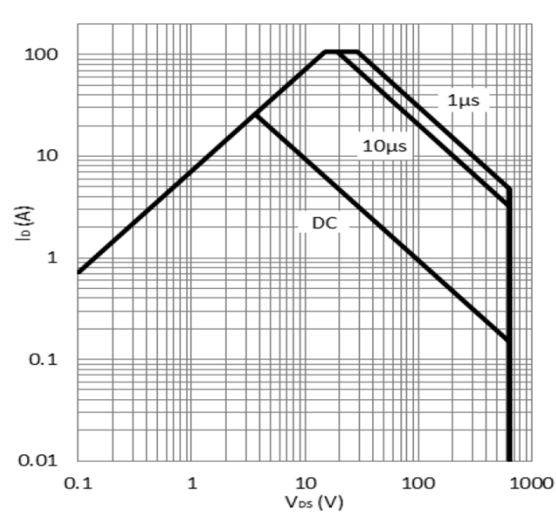
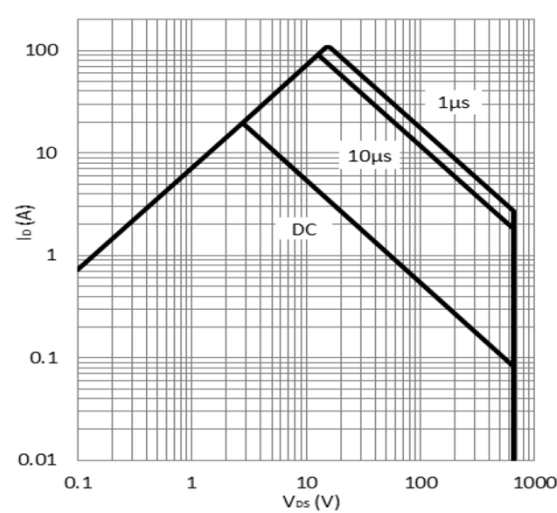


Figure 14. Safe Operating Area $T_c=25^\circ\text{C}$



calculated based on thermal limit

Figure 15. Safe Operating Area $T_c=80^\circ\text{C}$



calculated based on thermal limit

Test Circuits and Waveforms

Figure 16. Switching Time Test Circuit

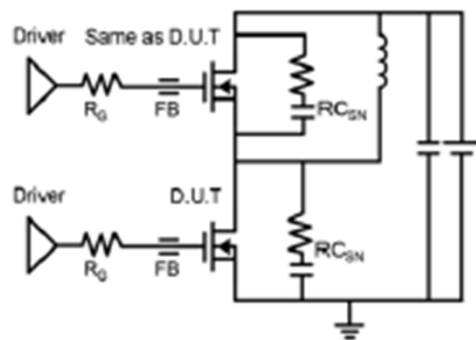


Figure 17. Switching Time Waveform

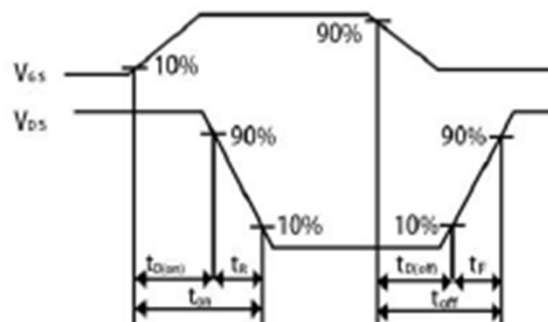
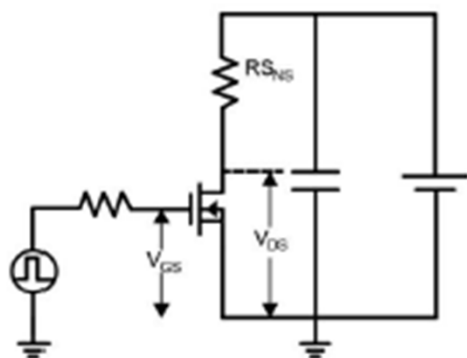
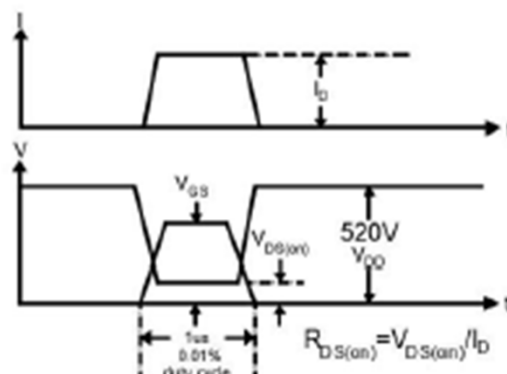
Figure 18. Dynamic $R_{DS(on)}$ Test CircuitFigure 19. Dynamic $R_{DS(on)}$ Waveform

Figure 20. Diode Characteristic Test Circuits

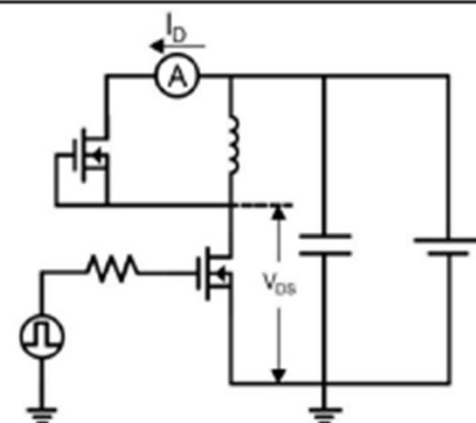
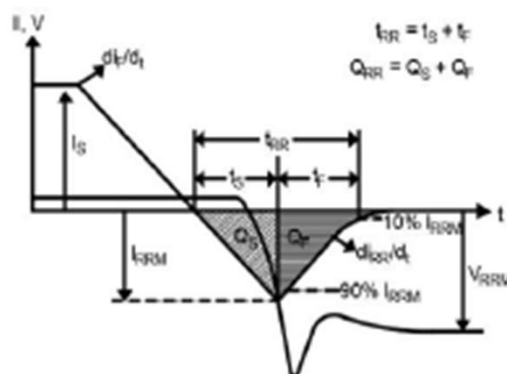
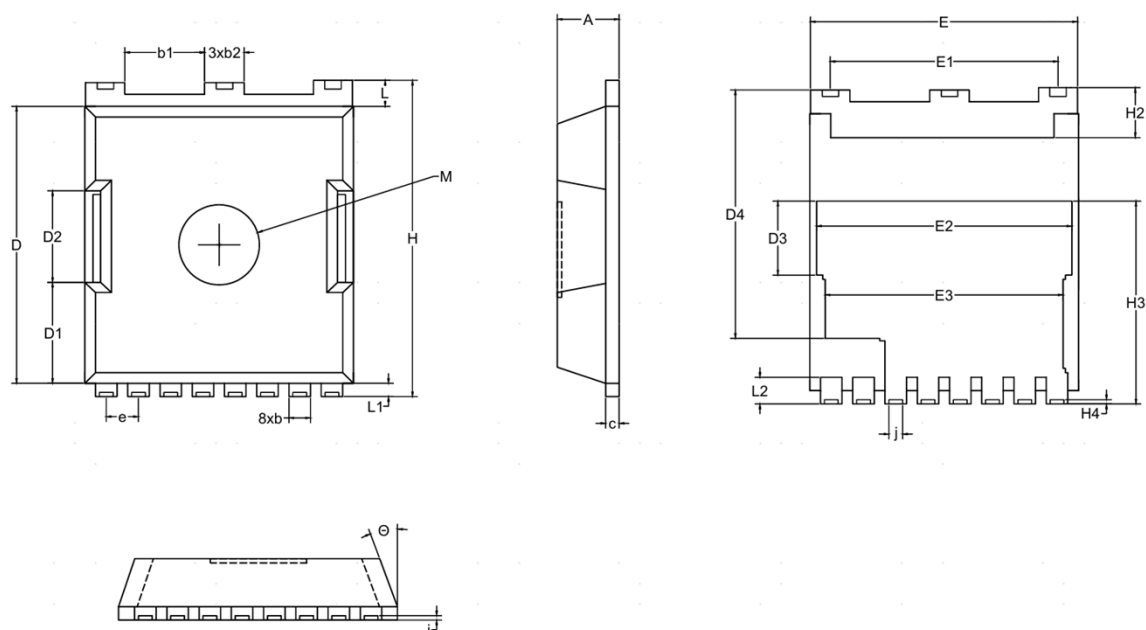


Figure 21. Diode Recovery Waveform




Product dimension (TOLL)



| SYMBOL | Millimeter | | |
|--------|------------|-------|-------|
| | Min | Nom | Max |
| A | 2.20 | 2.30 | 2.40 |
| b1 | 0.70 | 0.80 | 0.90 |
| b2 | 1.10 | 1.20 | 1.30 |
| c | 0.40 | 0.50 | 0.60 |
| D | 10.28 | 10.38 | 10.58 |
| D1 | 4.18REF | | |
| D2 | 3.30 REF | | |
| D3 | 2.77REF | | |
| D4 | 9.03REF | | |
| E | 9.70 | 9.90 | 10.10 |
| E1 | 8.50REF | | |
| E2 | 9.40REF | | |
| E3 | 8.50REF | | |
| e | 1.10 | 1.20 | 1.30 |
| H | 11.48 | 11.68 | 11.88 |
| H2 | 1.10 | 1.20 | 1.30 |
| H3 | 7.50 | 7.60 | 7.70 |
| H4 | 0.13 | 0.23 | 0.33 |
| i | 0.10 | - | - |
| j | 0.42 | 0.45 | 0.50 |
| L | 0.50 | 0.70 | 0.90 |
| L1 | 0.50 | 0.60 | 0.70 |
| L2 | 1.05 | 1.20 | 1.30 |
| M | 3REF | | |
| e | 10°REF | | |


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